MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model: MI0560DT-4

For Customer's Acceptance:

Customer	
Approved	
Comment	

Revision	1.0
Engineering	
Date	2013-04-11
Our Reference	



REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2013-04-11	First release	

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■ GENERAL INFORMATION

Item	Contents	Unit
LCD type	TFT/Transimissive/Normally white	/
Size	5.6	Inch
Viewing direction	12:00	O' Clock
Gray scale inversion direction	6:00	O' Clock
$LCM(W \times H \times D)$	126.50×100.00×5.70	mm ³
Active area (W×H)	113.28×84.708	mm ²
Pixel pitch (W×H)	0.118×0.362	mm ²
Number of dots	320 (RGB) × 234	/
Backlight type	14 LEDs	/
Interface type	Analog RGB	/
Color depth	Full color	/
Pixel configuration	R.G.B vertical stripe	/
Surface treatment(Up polarizer)	Anti-glare	/
Input voltage	5.0	V
With/Without TSP	Without TSP	/
Weight	123	g

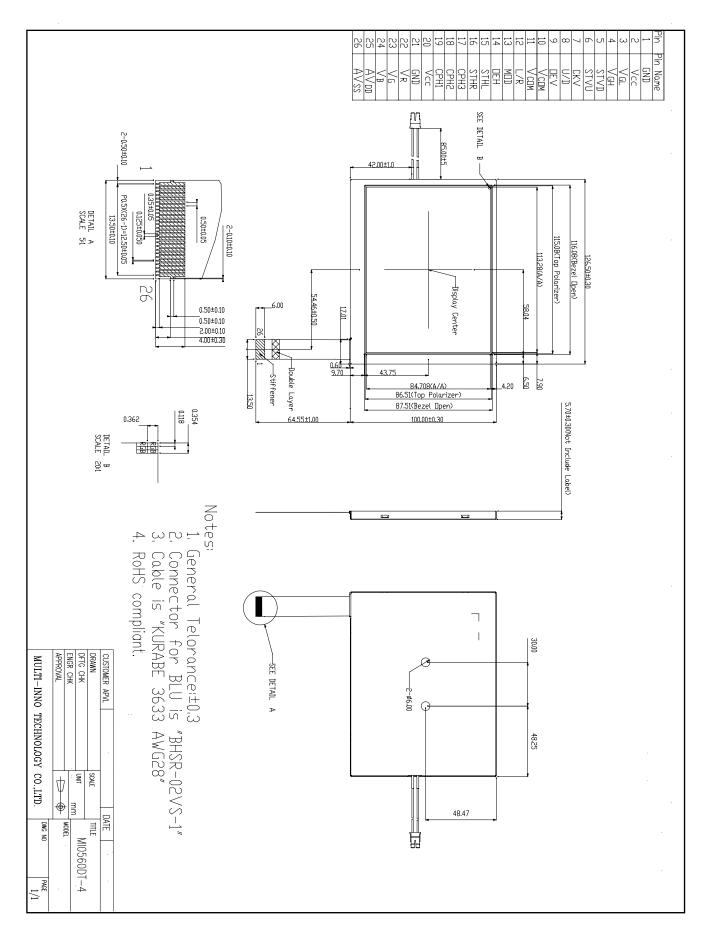
Note 1:Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2 : RoHS compliant;

Note 3: LCM weight tolerance: \pm 5%.



■ EXTERNAL DIMENSIONS





■ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
	VCC	-0.3	7.0	V
Down voltage	AVDD	-0.3	7.0	V
Power voltage	VGH	-0.3	18.0	V
	VGL	-15.0	0.3	V
	VGH-VGL	-	33.0	V
Input signal voltage	V_A	-0.2	AVDD+0.2	V
input signal voltage	V_L	-0.3	AVDD+0.3	V
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max60°C)	RH

Note 1: VR, VG, VB

Note 2: STHL, STHR, OEH, L/R, CPH1-3, STVU, STVD, OEV, CKV, U/D

■ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

Parameter	Symbol	Min	Тур	Max	Unit
Logic supply voltage	VCC	4.8	5.0	5.2	V
Analog supply voltage	AVDD	4.8	5.0	5.2	V
Negative power for scan driver	VGL	-10.5	-10.0	-9.5	V
Positive power for scan driver	VGH	14.3	15.0	15.7	V
Inputvoltage'H'level	VIH	0.8VCC	-	VCC	V
Inputvoltage'L'level	VIL	0	-	0.2VCC	V
Outputvoltage'H'level	VOH	0.8VCC	-	VCC	V
Outputvoltage'L'leve	VOL	0	-	0.2VCC	V
	V _{IA}	0.2	-	AVDD- 0.2	V
Video signal amplitude	V_{IAC}	-	3.5	-	V
	V_{IDC}	-	AVDD/2	-	V
VCOM	V_{CAC}	-	5.4	-	V
VCOM	$V_{\mathtt{CDC}}$	1.55	1.7	1.95	V
	I _{VCC}	-	0.8	1.2	mA
Power consumption	I_{AVDD}	-	3.41	5.12	mA
1 ower consumption	I_{VGH}	-	0.056	0.084	mA
	I_{VGL}	-	0.056	0.084	mA

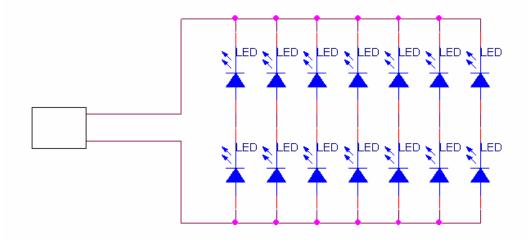
Note 1: STHL, STHR, OEH, L/R, CPH1-3, STVU, STVD, OEV, CKV, U/D

Note 2: Test condition: Voltage fix on: VCC=5.0V, AVDD=5.0V, VGH=15.0V, VGL=-10V

■ BACKLIGHT CHARACTERISTICS

Item	Symbol	Min	Тур	Max	Unit	Remark
Forward Current	I _F	-	140	-	mA	
Forward Current Voltage	V_{F}	-	6.4	-	V	Note 1
Backlight Power Consumption	W_{BL}	-	896	-	mW	
Operating Life Time		10000	(20000)		hrs	Note 2

Note1: For each LED, I_L=20mA



LED driver circuit

Note 2: I_F is defined for one channel LED.

Optical performance should be evaluated at Ta=25°C only.

If LED is driven by high current, high ambient temperature & humidity condition.

The life time of LED will be reduced.

Operating life means brightness goes down to 50% initial brightness.

Typical operating life time is estimated data.



■ELECTRO-OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min	Тур	Max	Unit	Remark	Note
Response time	Tr +Tf		-	50	100	ms	Fig.1	4
Contrastratio	Cr	θ=0°	200	300	-		FIG 2.	1
Luminance uniformity	δ WHITE	Ø=0° Ta=25℃	70	80	-	%	FIG 2.	3
Surface Luminance	Lv	1 a-25 C	300	330	-	cd/m ²	FIG 2.	2
		Ø = 90°	35	45	-	deg	FIG 3.	
Viewing angle range	θ	Ø = 270°	55	65	-	deg	FIG 3.	6
	0	$\emptyset = 0$ °	55	65	-	deg	FIG 3.] 0
		Ø = 180°	55	65	-	deg	FIG 3.	
	Red x		0.535	0.585	0.635			
	Red y		0.292	0.342	0.392			
	Green x	θ=0°	0.276	0.326	0.376			
CIE (x, y) chromaticity	Green y		0.525	0.575	0.625		FIG 2.	5
	Blue x	Ø=0°	0.091	0.141	0.191		110 2.]
	Blue y	Ta=25℃	0.060	0.110	0.160			
	White x		0.260	0.310	0.360			
	White y		0.280	0.330	0.380			
NTSC Ratio	S		45	50	-	%		

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.:

Contrast Ratio = Average Surface Luminance with all white pixels (P₁,P₂, P₃,P₄, P₅)

Average Surface Luminance with all black pixels (P₁, P₂, P₃,P₄, P₅)

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels $(P_1, P_2, P_3, P_4, P_5)$

Note 3. The uniformity in surface luminance , δ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

 $\delta \text{ WHITE} = \frac{\text{Minimum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}{\text{Maximum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}$

Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series

Note 5. CIE (x, y) chromaticity, The x,y value is determined by measuring luminance at each test position 1 through 5, and then make average value

Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity, CIE The test data is base on TOPCON's BM-5 photo detector.

Note 8. For TFT module, Gray scale reverse occurs in the direction of panel viewing angle.



FIG.1. The definition of Response Time

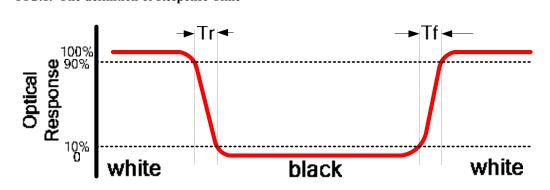


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity

A:5 mm

B:5 mm

H,V: Active Area

Light spot size \varnothing =5mm, 500mm distance from the

LCD surface to detector lens

measurement instrument is TOPCON's luminance

meter BM-5

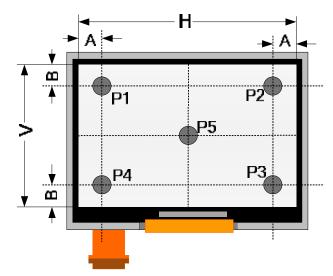
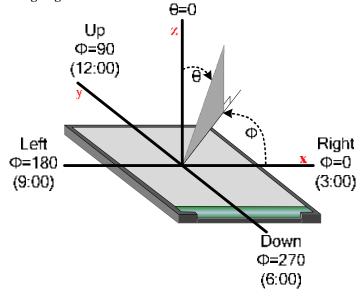
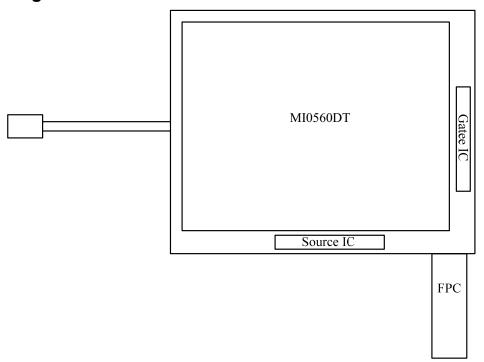


FIG.3. The definition of viewing angle



■ INTERFACE DESCRIPTION

1. BlockDiagram



2. Interface Signals

2.1 TFT LCD panel driving section

FPC Connector type is: FH12-26S-0.5SH

No	Symbol	I/O	Description	Remark
1	GND	Р	Ground	
2	VCC	Р	Supply voltage for scan driver	
3	VGL	Р	Negative power for scan driver	
4	VGH	Р	Positive power for scan driver	
5	STVD	I/O	Vertical start pulse down side	Note 1
6	STVU	I/O	Vertical start pulse up side	Note 1
7	CKV	I	Shift clock input	
8	U/D	I	UP/DOWN scan control input	Note 1
9	OEV		Output enable control for scan	
10	VCOM	I	Common electrode driving signal	
11	VCOM	I	Common electrode driving signal	
12	L/R	I	LEFT/RIGHT scan control input	Note 1
13	MOD	I	Sequential sampling and simultaneous sampling setting	Note 2
14	OEH	I	Output enable control for data driver	
15	STHL	I/O	Start pulse for horizontal scan line left side	Note 1
16	STHR	I/O	Start pulse for horizontal scan line right side	Note 1
17	CPH3	I	Sampling and shifting clock pulse for data driver	Note 2
18	CPH2	I	Sampling and shifting clock pulse for data driver	Note 2
19	CPH1	I	Sampling and shifting clock pulse for data driver	Note 2
20	VCC	Р	Supply voltage for data driver	
21	GND	Р	Ground	
22	VR	I	Alternated video signal(Red)	
23	VG		Alternated video signal(Green)	
24	VB	I	Alternated video signal(Blue)	
25	AVDD	Р	Supply voltage for analog circuit	_
26	AVSS	Р	Ground for analog circuit	

Table 2.1 input terminal pin assignment

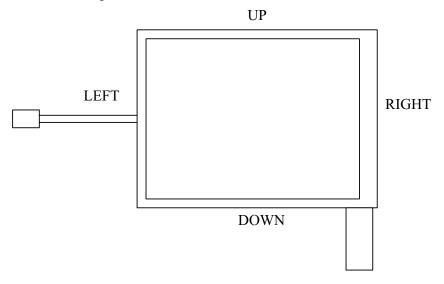
I: input pin; I/O: input/output pin; P: Power/GND;

Note 1: select of scanning mode

Setting of sc	In/out sta	ate for st	art pulse		Soonning direction	
U/D	L/R	STVD	STVU	STHR	STHL	Scanning direction
GND	VCC	0	I	0	I	Up to down, left to right
VCC	GND	1	0	I	0	Down to up, right to left
GND	GND	0	I	I	0	Up to down, right to left
VCC	VCC	1	0	0	I	Down to up, left to right



Refer to the figure as below



Note 2: MOD=H, simultaneous sampling.
MOD=L, sequential sampling.
Please set CPH2 and CPH3 to GND when MOD=H.

2.2 Backlight unit section

Pin No.	Symbol	I/O	Function	Remark
1	HI	Р	Power supply for backlight unit	Pink line
2	GND	Р	Ground for backlight unit	White line



■ APPLICATION NOTES

1 Timing Chart

1.1 Timing Parameter

Parameter	Symbol	Min.	Тур.	Max.	Unit.	Remark
Rising time	t _r	-	-	60	ns	Note 1
Falling time	t _f	-	-	60	ns	Note 1
High and low level pulse width	t _{CPH}	150	154	158	ns	CPH1-3
CPH pulse width	t _{CWH}	40	50	60	%	CPH1-3
	t _{C12}					
CPH pulse delay	t _{C23}	30	t _{CPH} /3	t _{CPH} /2	ns	CPH1-3
	t _{C31}					
STH setup time	t _{SUH}	20	-	-	ns	STHL/R
STH hold time	t _{HDH}	20	-	-	ns	STHL/R
STH pulse width	t _{STH}	-	1	-	t _{CPH}	STHL/R
STH period	t _H	61.5	63.5	65.5	us	STHL/R
OEH pulse width	t _{OEH}	-	7	-	us	
Sample and hold disable time	t _{DIS1}	-	55	-	us	
OEV pulse width	t _{OEV}	-	27	-	us	
CKV pulse width	t _{CKV}	16	-	40	us	
Clean enable time	t _{DIS2}	-	16	-	us	
Horizontal display time range	t _{DH}	-	960	-	t _{CPH} /3	
STV setup time	t _{SUV}	400	-	-	ns	STVD/U
STV hold time	t _{HDV}	400	-	-	ns	STVD/U
STV pulse width	t _{STV}	-	-	1	t _H	STVD/U
Horizontal line per field	t _V	256	262.5	268	t _H	Note 2
Vertical display start	t _{SV}	-	3	-	t _H	
Vertical display range	t _{DV}	-	234	-	t _H	
Vertical start line	t _{SLV}	-	-	21	t _H	
VCOM rising time	t _{rCOM}	-	-	5	us	
VCOM falling time	t _{fCOM}	-	-	5	us	
VCOM delay time	t _{DCOM}	-	-	3	us	
RGB delay time	t _{DRGB}	-	-	1	us	

Note 1: For all of logic signal.

Note 2: Please don't use odd horizontal lines to drive LCD panel for both odd and even field simultaneously.



1.2 Timing Diagram

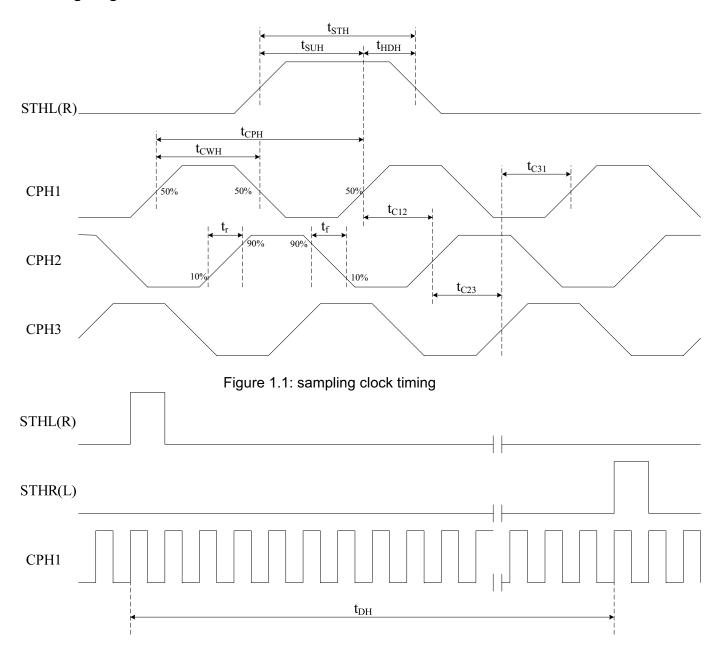


Figure 1.2: horizontal display range timing



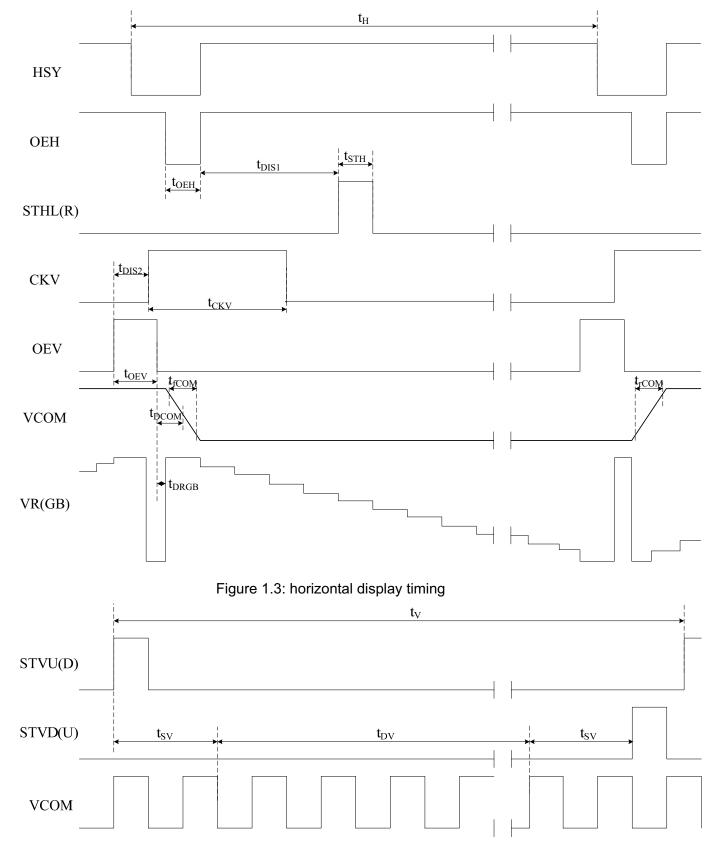


Figure 1.4: vertical display timing



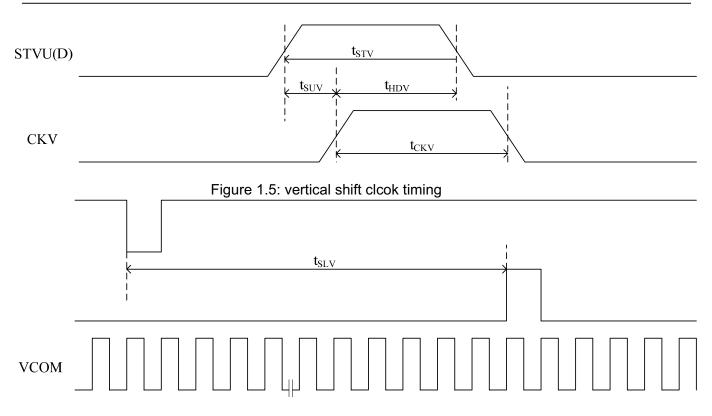


Figure 1.5: vertical start line timing



1.2. Power on/off Sequence

1.2.1 Power on Sequence

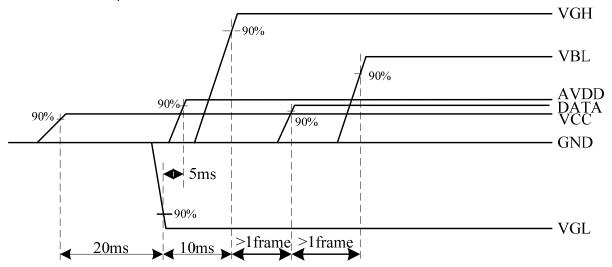


Figure 5.6 Power on sequence

VCC→VGL→AVDD→VGH→DATA→VBL

Note: the interval time should more than the label 1.2.2 Power off Sequence

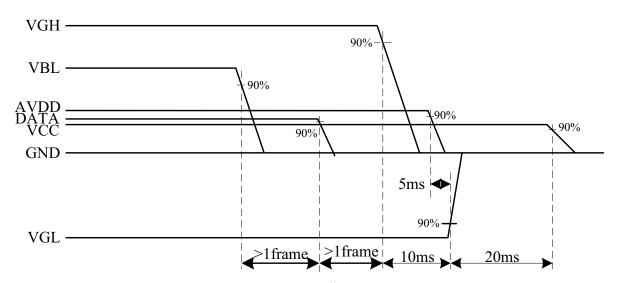


Figure 5.7 Power off sequence

VBL→DATA→VGH→AVDD→VGL→VCC

Note: the interval time should more than the label



■ RELIABILITY TEST

No.	Test Item	Test Condition	Remark
1	High Temperature Storage	80±2°C/240 hours	IEC60068-2-1 GB2423.2
2	Low Temperature Storage	-30±2°C/240 hours	IEC60068-2-1 GB2423.1
3	High Temperature Operating	70 ± 2 °C/240 hours	Note 1,IEC60068-2-1 GB2423.2
4	Low Temperature Operating	-20±2°C/240 hours	IEC60068-2-1 GB2423.1
5	Temperature Cycle storage	$-30\pm2^{\circ}\text{C}\sim25\sim80\pm2^{\circ}\text{C}\times100\text{cycles}$ (30min.) (5min.) (30min.)	Start with cold temperature, End with high temperature, IEC60068-2-14 GB2423.22
6	Damp proof Test operating	$60^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\%\text{RH/240 hours}$	Note 2,IEC60068-2-78 GB/T2423.3
7	Vibration Test (non-operation)	Frequency range:10Hz~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2hours for each direction of X,Y,Z(6 hours for total)	IEC60068-2-6 GB/T2423.10
8	Package drop test	Height:80 cm,1 corner,3 edges,6 surfaces	IEC60068-2-32,GB2423.8
9	ESD test (operation)	\pm 2KV,Human Body Mode, 100pF/1500 Ω	IEC61000-4-2 GB/T17626.2
10	Shock(non-operation)	100G 6ms, $\pm X$, $\pm Y$, $\pm Z$ 3times each direction	IEC60068-2-27 GB/T2423.5
11	Package vibration test	Random Vibration: 0.015G*G/Hz for 5-200Hz,-6dB/Octave from 200-500Hz 2 hours for each direction of X,Y,Z (6 hours for total)	IEC60068-2-34

Note 1:Ts is the temperature of panel's surface. Note 2:Ta is the ambient temperature of sample.

■ INSPECTION CRITERION

MIF	OUTGOING QUALITY STANDARD	PAGE 1 OF 6
TITLE:FUNCTIO	NAL TEST & INSPECTION CRITERIA	

This specification is made to be used as the standard acceptance/rejection criteria for Wider Screen TFT-LCD module product.

1. Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

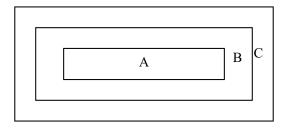
Major defect: AQL 0.65 Minor defect: AQL 1.5

2. Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line. (Normal temperature 20~25° C and normal humidity 60± 15% RH).

3. Definition of Inspection Item.

3.1 Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

ZoneB+ZoneC= Around opaque <u>edge</u> area on TP.

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

3.2 Definition of some visual defect

Bright dot.	Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern.
Dark dot.	Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue picture, or pure whiter picture.
Dark / Bright Lines.	Lines on display which appear dark/bright and usually result from the contamination.





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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

4. Major Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
4.1	All functional defects	 No display Display abnormally Open or missing segment Short circuit Excess power consumption Back-light no lighting, flickering and abnormal lighting. 	
4.2	Missing	Missing component	Major
4.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.	
4.4	Crack	Creaks tend to break are not allowed.	

5. Minor Defect

Item No	Items to be inspected	Inspection Standard				Classification of defects
	Bright dot. defect.	Zone	1	Acceptable	Qty	
		Size(mm)	A	В	C	
5.1		Ф≤0.15	Acceptable of spot not		Acceptable	
	$\Phi = (x+y)/2$	0.15<Φ≤0.25	N≤	€6.		
		0.25< Ф ≤ 0.50	N≤	€2		
						Minor
	Dark dot defect.	Zone		Acceptable	Q'ty	
		Size(mm)	A	В	С	
5.2		Ф ≤ 0.15	Acceptable			
		0.15<Φ≤0.30) N:	€6	Acceptable	
		0.30<Φ≤0.5	50 N:	≪4		
5.3	Bright / Dark line.	$0.01 < W \le 0.10, 0.30 < L \le 1.50, $ $N \le 1$		Acceptable		

Note: 1. Total defective dots shall not exceed 6 pcs.

- 2. Minimum distance between defective dots is more than 5mm.
- 3. 2 Adjacent dark sub pixel defect or bright sub pixel defect is not more than 1pair.
- 4. W: Width, L: Length, N: Count.





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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

Item No	Items to be inspected	Inspection Standard					Classification of defects
							Minor
	Linear defect	Siz	ze(m)	Acce	eptable Qty		
	Foreign material under polarizer,	L(Length)	W(Width)	A	Zone	С	
		Ignore	W≤0.05	Acce	eptable	Aco	
		L≤5.0	0.05 <w≤0.1< td=""><td>5</td><td>N≤5</td><td>Acceptable</td><td></td></w≤0.1<>	5	N≤5	Acceptable	
- 4		5.0≤L	0.15≤W		0	ole	
5.4	Circular Defect,						Minor
	Foreign material	Zoi	ne .	Acceptab	le Q'ty		
	under polarizer,	Cirro(mm)	A	В	С		
	() j y	Size(mm) $\Phi \leq 0.25$	Acce	l ptable			
	<u> </u>			N≤4		able	
	$\Phi = (x+y)/2$	0.50≤Φ		0			
5.5	Polarizer defect.	dimension (ii) Incomplete is not allo 5.4.2 Dirt on po	a position should be covering of the lowed. larizer can be wiped e lowed. A Acceptage A	Acceptab Zon B otable	rea due to shi	fting ted.	Minor





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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

5. Minor Defect

Item No	Items to be inspected	Inspection Standard					Classification of defects
		5.4.4Air bubbles between glass & polarizer:					Minor
				Acc	eptab	le Qty	
		Size(mm)		Zon	e	
			A		В	С	
		Φ <		ceptab	ole		
		0.3<4		3		Acceptable	
		1.0<4		1		-	
		Φ>	1.5	0			
		5.4.5 Polarizer	scratch				Minor
5.6	Polarizer defect	 (i) If the Polarizer scratch can be seen after cover assembling or in the operating condition, judge by the line defect of 5.4. (ii) If the Polarizer scratch can be seen only in non-operating condition or some special angle, judge by the following. 		y n			
		Size(mm)		A	Accept	table Qty	
		I (I d)			Zone		
		L(Length)	W(Width)	A	В	С	
		Ignore	W≤0.02	Ig	nore		
		1.0 <l≤5.0< td=""><td>0.02<w≤0.2< td=""><td>N</td><td>≪4.</td><td>Ignore</td><td></td></w≤0.2<></td></l≤5.0<>	0.02 <w≤0.2< td=""><td>N</td><td>≪4.</td><td>Ignore</td><td></td></w≤0.2<>	N	≪ 4.	Ignore	
		5.0 <l< td=""><td>0.2<w< td=""><td></td><td colspan="2">0</td><td></td></w<></td></l<>	0.2 <w< td=""><td></td><td colspan="2">0</td><td></td></w<>		0		







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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

5. Minor Defect

Item No	Items to be inspected		Inspection Standard		Classificatio n of defects
		(i) Crack Cracks are not alle	owed.		Minor
		(ii) TFT chips on corr	ner		Minor
5.7	Glass defect	X Y ≤3.0 ≤3.0	Z Not more than the thickness of glass.	Acceptable N≤3.	
		e allowed to extend	1		
		(iii)Usual surface crac	cks	* * * * *	Minor
		X Y	Z	Acceptable	
		≤1.5 ≤1.5	Not more than the thickness of glass.	N≤4.	





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TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

Item No	Items to be inspected	Inspection Standard	Classification of defects
1	Difference in Spec.	None allowed	Major
2	Pattern peeling	No substrate pattern peeling and floating	Major
3	Soldering defects	No soldering missing No soldering bridge No cold soldering	Major Major Minor
4	Resist flaw on Printed Circuit Boards	visible copper foil (Ø0.5mm or more) on substrate pattern.	Minor
5	Accretion of metallic Foreign matter	No accretion of metallic foreign matters (Not exceed \emptyset 0.2mm).	Minor Minor
6	Stain	No stain to spoil cosmetic badly.	Minor
7	Plate discoloring	No plate fading, rusting and discoloring.	Minor
8	Solder amount 1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly. (too much) b. Components side (In case of 'Through Hole PCB')	Minor
	2. Flat packages	Solder to reach the Components side of PCB. Either 'Toe' (A) or 'Seal' (B) of the lead to be covered by 'Filet'. Lead form to be assume over solder.	Minor
	3. Chips	$(3/2) H \ge h \ge (1/2) H$	Minor
9	Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad $h \ge 0.13$ mm. The diameter of solder ball d ≤ 0.15 mm. d $\downarrow h$ b. The quantity of solder balls or	Minor
		solder. Splashes isn't beyond 5 in 600 mm ² .	Minor
		c.Solder balls/Solder splashes do not violate minimum electrical clearance. d.Solder balls/Solder splashes must be entrapped / encapsulated or attached to the metal surface .	Major Minor
		Note: Entrapped/encapsulated/attached is intended to mean that normal service environment of the product will not cause a solder ball to become dislodged.	



■ PRECAUTIONS FOR USING LCD MODULES

1 Handing Precautions

- 1.1 The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- 1.2 If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- 1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- 1.5 If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- 1.6 Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contact with oil and fats.

- 1.7 Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 1.8 Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 1.9 Do not attempt to disassemble or process the LCD module.
- 1.10 NC terminal should be open. Do not connect anything.
- 1.11 If the logic circuit power is off, do not apply the input signals.
- 1.12 Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Before removing LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
 - To reduce the amount of static electricity generated, do not conduct assembling



and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dry. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

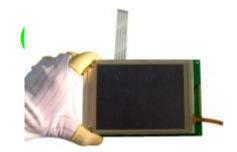
- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- 1.13 Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
 - Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
 - Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
 - Do not drop, bend or twist the LCM.



2 Handling precaution for LCM

- 2.1 LCM is easy to be damaged. Please note below and be careful for handling.
- 2.2 Correct handling:





As above picture, please handle with anti-static gloves around LCM edges.

2.3 Incorrect handling:



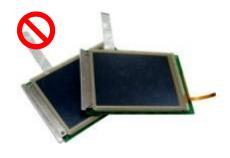
Please don't touch IC directly.



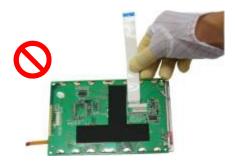
Please don't hold the surface of panel.



Please don't hold the surface of IC.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable.



Please don't operate with sharp stick such as pens.



3 Storage Precautions

- 3.1 When storing the LCD modules, the following precaution are necessary.
 - 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
 - 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH
 - 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).

3.2 Others 其它

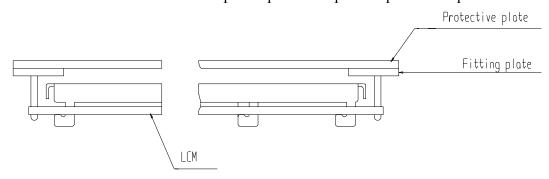
- 3.2.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- 3.2.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3.2.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - 3.2.3.1 Exposed area of the printed circuit board.
 - 3.2.3.2 -Terminal electrode sections.

4 USING LCD MODULES

4.1 Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

4.1.1 Cover the surface with a transparent protective plate to protect the polarizer and LC cell.

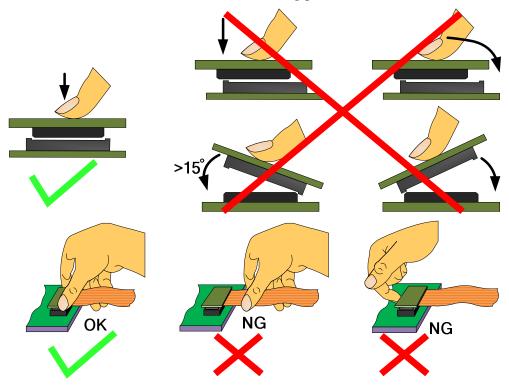


4.1.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.



4.2 Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows





4.3 Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS	290°C ~350°C.	330°C ~350°C.	300°C ~330°C.
Product	Time : 3-5S.	Speed: 15-17 mm/s.	Time : 3-6S.
Troduct			Press: 0.8~1.2Mpa
RoHS	340°C ~370°C.	350°C ~370°C.	330°C ~360°C.
Product	Time : 3-5S.	Speed: 15-17 mm/s.	Time : 3-6S.
Troduct			Press: 0.8~1.2Mpa

- 4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- 4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

4.4 Precautions for Operation

- 4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- 4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- 4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
- 4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
- 4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.
- 4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.



4. 6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

4.7 Return LCM under warranty

- 4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :
 - 4.7.1.1 Broken LCD glass.
 - 4.7.1.2 PCB eyelet is damaged or modified.
 - 4.7.1.3 -PCB conductors damaged.
 - 4.7.1.4 Circuit modified in any way, including addition of components.
 - 4.7.1.5 PCB tampered with by grinding, engraving or painting varnish.
 - 4.7.1.6 Soldering to or modifying the bezel in any manner.
- 4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PACKING SPECIFICATION

Please consult our technical department for detail information.

■ PRIOR CONSULT MATTER

- For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- 3 If you have special requirement about reliability condition, please let us know before you start the test on our samples.